FC-135

SEIKO EPSON CORPORATION

Product name FC-135 Product Number / Ordering code

32.768000 kHz 12.5 +10.0-10.0

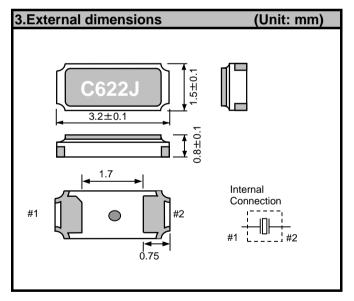
Q13FC13500005xx

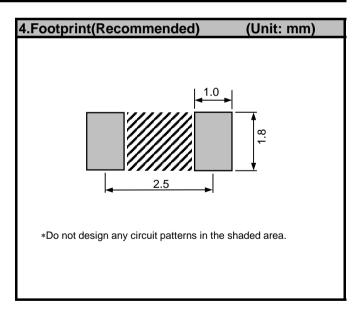
Please refer to the 5.Packing information about xx (last 2 digits)

Complies with EU RoHS directive Reference weight Typ. 11 mg

| 1.Absolute maximum ratings | | | | | | | | |
|----------------------------|--------|------|------|------|------|---------------------------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions / Remarks | | |
| Storage temperature | T_stg | -55 | - | 125 | °C | Storage as single product | | |
| Maximum drive level | GL | • | - | 0.5 | μW | | | |

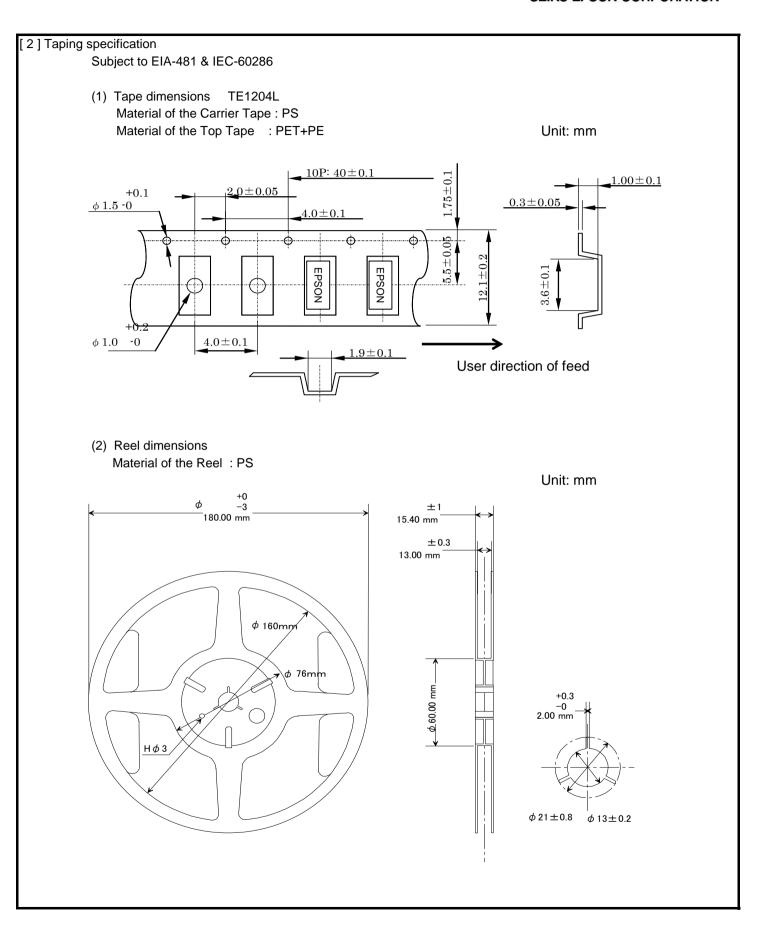
| 2.Specificatoins(characteristics) | | | | | | |
|-----------------------------------|--------|-------|--------|-------|-------------------------------------|----------------------|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Conditions / Remarks |
| Nominal frequency | f_nom | - | 32.768 | - | kHz | |
| Operating temperature | T_use | -40 | - | 85 | ۰C | |
| Level of drive | DL | - | 0.1 | 0.5 | μW | |
| Frequency tolerance | f_tol | -10.0 | - | +10.0 | x 10 ⁻⁶ | +25°C DL=0.1μW |
| Turnover temperature | Ti | 20 | 25 | 30 | ٥C | |
| Parabolic coefficient | В | - | - | -0.04 | x 10 ⁻⁶ /°C ² | |
| Load capacitance | CL | - | 12.5 | - | pF | |
| Motional resistance (ESR) | R1 | - | - | 70 | kΩ | |
| Motional capacitance | C1 | - | 3.4 | - | fF | |
| Shunt capacitance | C0 | - | 1 | - | pF | |
| Motional inductance | L1 | - | 7.1 | - | kH | |
| Frequency aging | f_age | -3 | - | 3 | x10 ⁻⁶ /yea | @+25°C, First year |





| 5.Packing | informati | on | | | |
|------------|---|------------------------------|------------------------------|----------------|--|
| [1]Product | [1]Product number last 2 digits code (xx) description | | The recommended code is "00" | | |
| | Q13FC13 | 500005xx | | | |
| | Code | Condition | Code | Condition | |
| | 01 | Any Q'ty vinyl bag(Tape cut) | 14 | 1000pcs / Reel | |
| | 11 | Any Q'ty / Reel | 15 | 2000pcs / Reel | |
| | 12 | 250pcs / Reel | 00 | 3000pcs / Reel | |
| | 13 | 500pcs / Reel | | | |

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Reflow profile

Pre Heating Temperature

Tp1 ~ Tp2 = + 170 °C

Heating Temperature

TMlt = + 220 °C Peek Temperature

The conference

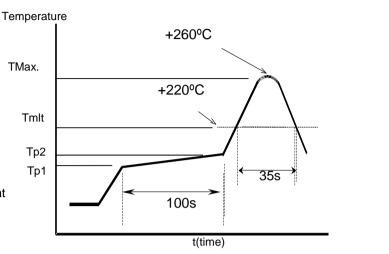
TMax. = + 260 °C

Point of measuring

In case of Solder ability

Terminal.

In case of Resistance to soldering heat Surface.



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